



# CHENMKO ENTERPRISE CO.,LTD

## SURFACE MOUNT

### Dual Enhancement Mode Field Effect Transistor

N-channel: VOLTAGE 40 Volts CURRENT 6.1 Ampere

P-channel: VOLTAGE 40 Volts CURRENT 5.2 Ampere

CHM4269JGP

Halogens free devices

#### APPLICATION

- \* Servo motor control.
- \* Power MOSFET gate drivers.
- \* Other switching applications.

#### FEATURE

- \* Small flat package. (SO-8 )
- \* Super high dense cell design for extremely low  $R_{DS(ON)}$ .
- \* Lead free product is acquired.
- \* High power and current handling capability.

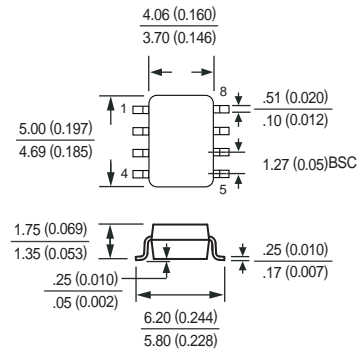
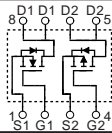
#### CONSTRUCTION

- \* N-Channel & P-Channel Enhancement in the package



SO-8

#### CIRCUIT



Dimensions in millimeters

SO-8

#### Absolute Maximum Ratings $T_A = 25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	N-Channel	P-Channel	Units
$V_{DSS}$	Drain-Source Voltage	40	-40	V
$V_{GSS}$	Gate-Source Voltage	$\pm 20$	$\pm 20$	V
$I_D$	Maximum Drain Current - Continuous	6.1	-5.2	A
	- Pulsed (Note 3)	20	-20	
$P_D$	Maximum Power Dissipation at $T_a=25^\circ\text{C}$	2000		mW
$T_J$	Operating Temperature Range	-55 to 150		$^\circ\text{C}$
$T_{STG}$	Storage Temperature Range	-55 to 150		$^\circ\text{C}$

- Note : 1. Surface Mounted on FR4 Board ,  $t \leq 10\text{sec}$   
 2. Pulse Test , Pulse width  $\leq 300\mu\text{s}$  , Duty Cycle  $\leq 2\%$   
 3. Repetitive Rating , Pulse width limited by maximum junction temperature  
 4. Guaranteed by design , not subject to production testing

#### Thermal characteristics

$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient (Note 1)	62.5	$^\circ\text{C/W}$
-----------------	--	------	--------------------

2007-06

## ELECTRICAL CHARACTERISTIC ( CHM4269JGP )

### N-Channel Electrical Characteristics $T_A = 25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Conditions	Min	Typ	Max	Units
--------	-----------	------------	-----	-----	-----	-------

#### OFF CHARACTERISTICS

$BV_{DSS}$	Drain-Source Breakdown Voltage	$V_{GS} = 0\text{ V}, I_D = 250\ \mu\text{A}$	40			V
$I_{DSS}$	Zero Gate Voltage Drain Current	$V_{DS} = 40\text{ V}, V_{GS} = 0\text{ V}$			1	$\mu\text{A}$
$I_{GSSF}$	Gate-Body Leakage	$V_{GS} = 20\text{ V}, V_{DS} = 0\text{ V}$			+100	nA
$I_{GSSR}$	Gate-Body Leakage	$V_{GS} = -20\text{ V}, V_{DS} = 0\text{ V}$			-100	nA

#### ON CHARACTERISTICS (Note 2)

$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_D = 250\ \mu\text{A}$	1		3	V
$R_{DS(on)}$	Static Drain-Source On-Resistance	$V_{GS}=10\text{V}, I_D=6\text{A}$			32	m $\Omega$
		$V_{GS}=4.5\text{V}, I_D=5\text{A}$			46	
$g_{FS}$	Forward Transconductance	$V_{DS} = 5\text{ V}, I_D = 6\text{ A}$		3		S

#### Dynamic Characteristics

$C_{iss}$	Input Capacitance	$V_{DS} = 20\text{ V}, V_{GS} = 0\text{ V},$ $f = 1.0\text{ MHz}$		1050		pF
$C_{oss}$	Output Capacitance			155		
$C_{rss}$	Reverse Transfer Capacitance			95		

#### SWITCHING CHARACTERISTICS (Note 4)

$Q_g$	Total Gate Charge	$V_{DS}=20\text{V}, I_D=6\text{A}$ $V_{GS}=10\text{V}$		20.5	27	nC
$Q_{gs}$	Gate-Source Charge			3.5		
$Q_{gd}$	Gate-Drain Charge			4.0		
$t_{on}$	Turn-On Time	$V_{DD} = 20\text{ V}$ $I_D = 6\text{ A}, V_{GS} = 10\text{ V}$ $R_{GEN} = 3\ \Omega$		14	30	nS
$t_r$	Rise Time			10	20	
$t_{off}$	Turn-Off Time			17	35	
$t_f$	Fall Time			18	35	

#### DRAIN-SOURCE DIODE CHARACTERISTICS AND MAXIMUM RATINGS

$I_S$	Drain-Source Diode Forward Current	(Note 1)			1.0	A
$V_{SD}$	Drain-Source Diode Forward Voltage	$I_S = 1.0\text{ A}, V_{GS} = 0\text{ V}$ (Note 2)			1.0	V

## ELECTRICAL CHARACTERISTIC ( CHM4269JGP )

### P-Channel Electrical Characteristics $T_A = 25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Conditions	Min	Typ	Max	Units
--------	-----------	------------	-----	-----	-----	-------

#### OFF CHARACTERISTICS

$BV_{DSS}$	Drain-Source Breakdown Voltage	$V_{GS} = 0\text{ V}, I_D = -250\ \mu\text{A}$	-40			V
$I_{DSS}$	Zero Gate Voltage Drain Current	$V_{DS} = -40\text{ V}, V_{GS} = 0\text{ V}$			-1	$\mu\text{A}$
$I_{GSSF}$	Gate-Body Leakage	$V_{GS} = 20\text{ V}, V_{DS} = 0\text{ V}$			+100	nA
$I_{GSSR}$	Gate-Body Leakage	$V_{GS} = -20\text{ V}, V_{DS} = 0\text{ V}$			-100	nA

#### ON CHARACTERISTICS (Note 2)

$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_D = -250\ \mu\text{A}$	-1		-3	V
$R_{DS(on)}$	Static Drain-Source On-Resistance	$V_{GS} = -10\text{ V}, I_D = -5\text{ A}$			43	m $\Omega$
		$V_{GS} = -4.5\text{ V}, I_D = -2\text{ A}$			65	
$g_{FS}$	Forward Transconductance	$V_{DS} = -5\text{ V}, I_D = -4.8\text{ A}$		3		S

#### Dynamic Characteristics

$C_{iss}$	Input Capacitance	$V_{DS} = -20\text{ V}, V_{GS} = 0\text{ V},$ $f = 1.0\text{ MHz}$		1115		pF
$C_{oss}$	Output Capacitance			205		
$C_{rss}$	Reverse Transfer Capacitance			120		

#### SWITCHING CHARACTERISTICS (Note 4)

$Q_g$	Total Gate Charge	$V_{DS} = -20\text{ V}, I_D = -5\text{ A}$ $V_{GS} = -10\text{ V}$		20	26	nC
$Q_{gs}$	Gate-Source Charge			3.3		
$Q_{gd}$	Gate-Drain Charge			4.1		
$t_{on}$	Turn-On Time	$V_{DD} = -20\text{ V}$ $I_D = -5\text{ A}, V_{GS} = -10\text{ V}$ $R_{GEN} = 3\ \Omega$		12	25	nS
$t_r$	Rise Time			5	10	
$t_{off}$	Turn-Off Time			40	80	
$t_f$	Fall Time			10	20	

#### DRAIN-SOURCE DIODE CHARACTERISTICS AND MAXIMUM RATINGS

$I_S$	Drain-Source Diode Forward Current	(Note 1)			-1.0	A
$V_{SD}$	Drain-Source Diode Forward Voltage	$I_S = -1.0\text{ A}, V_{GS} = 0\text{ V}$ (Note 2)			-1.0	V

# RATING CHARACTERISTIC CURVES ( CHM4269JGP )

## N-Channel Typical Electrical Characteristics

Figure 1. Output Characteristics

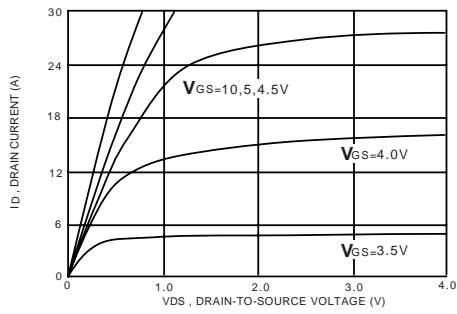


Figure 2. Transfer Characteristics

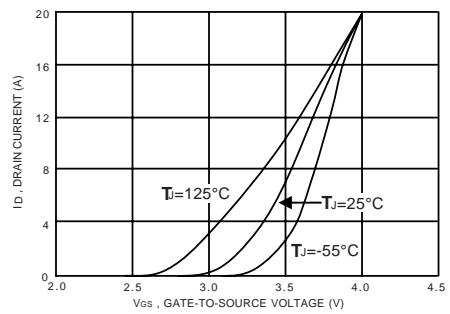


Figure 3. Gate Charge

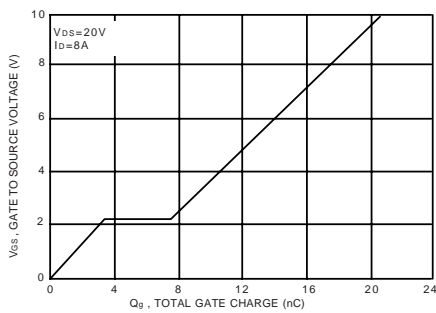


Figure 4. On-Resistance Variation with Temperature

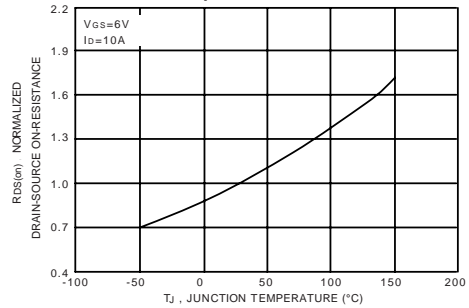
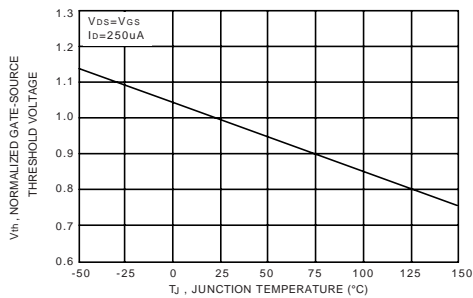


Figure 5. Gate Threshold Variation with Temperature



# RATING CHARACTERISTIC CURVES ( CHM4269JGP )

## P-Channel Typical Electrical Characteristics

Figure 1. Output Characteristics

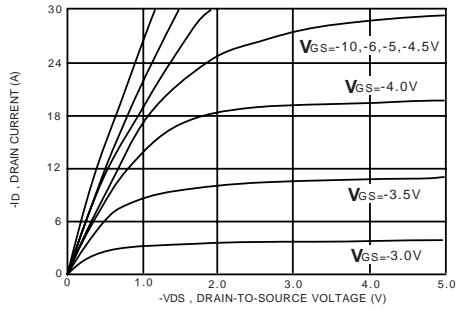


Figure 2. Transfer Characteristics

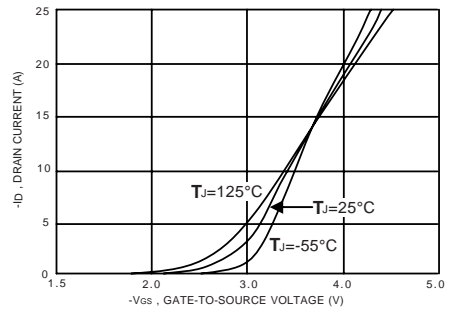


Figure 3. Gate Charge

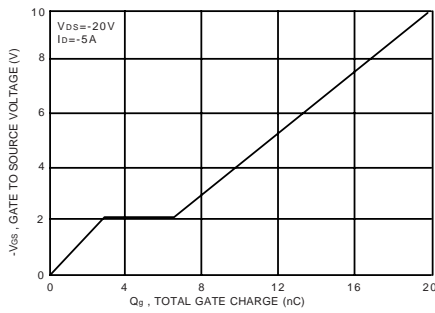


Figure 4. On-Resistance Variation with Temperature

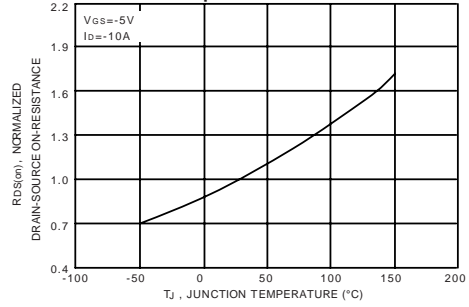


Figure 5. Gate Threshold Variation with Temperature

